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BAS521B

High-voltage switching diode

29 June 2018

Product data sheet

1. General description

High-voltage switching diode, in an ultra small SOD523 (SC-72) flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- High switching speed: $t_{rr} \leq 50$ ns
- Low leakage current: $I_R \leq 100$ nA
- High reverse voltage: $V_R \leq 200$ V
- Low capacitance: $C_d \leq 2$ pF
- Ultra small and leadless SMD plastic package
- AEC-Q101 qualified

3. Applications

- High-speed switching
- General-purpose switching
- Voltage clamping
- Reverse polarity protection

4. Quick reference data



Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
I_F	forward current	$T_j = 25$ °C	[1]	-	-	250	mA
V_{RRM}	repetitive peak reverse voltage			-	-	250	V
V_R	reverse voltage			-	-	200	V
V_F	forward voltage	$I_F = 200$ mA; $t_p \leq 300$ μ s; $\delta \leq 0.02$; $T_j = 25$ °C		-	-	1.25	V
I_R	reverse current	$V_R = 200$ V; pulsed; $T_j = 25$ °C		-	-	100	nA
t_{rr}	reverse recovery time	$I_F = 30$ mA; $I_R = 30$ mA; $R_L = 100$ Ω ; $I_{R(meas)} = 3$ mA; $T_j = 25$ °C		-	-	50	ns

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	 SOD523	 aaa-028035
2	A	anode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAS521B	SOD523	plastic, surface-mounted package; 2 leads; 1.2 mm x 0.8 mm x 0.6 mm body	SOD523

7. Marking

Table 4. Marking codes

Type number	Marking code
BAS521B	S2

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{RRM}	repetitive peak reverse voltage	$T_j = 25\text{ °C}$		-	250	V
V_R	reverse voltage			-	200	V
I_F	forward current		[1]	-	250	mA
I_{FSM}	non-repetitive peak forward current	$t_p = 50\text{ }\mu\text{s}$; $T_{j(\text{init})} = 25\text{ °C}$; square wave		-	9.4	A
		$t_p = 100\text{ }\mu\text{s}$; $T_{j(\text{init})} = 25\text{ °C}$; square wave		-	7.2	A
		$t_p = 10\text{ ms}$; $T_{j(\text{init})} = 25\text{ °C}$; square wave		-	2.4	A
I_{FRM}	repetitive peak forward current	$t_p \leq 1\text{ ms}$; $\delta \leq 0.25$		-	625	mA
P_{tot}	total power dissipation	$T_{\text{amb}} \leq 25\text{ °C}$	[1]	-	250	mW
			[2]	-	380	mW
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated mounting pad for cathode 1 cm^2 .

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{\text{th}(j-a)}$	thermal resistance from junction to ambient	In free air	[1]	-	-	500	K/W
			[2]	-	-	330	K/W
$R_{\text{th}(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	95	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated mounting pad for cathode 1 cm^2 .

[3] Soldering point of cathode tab.

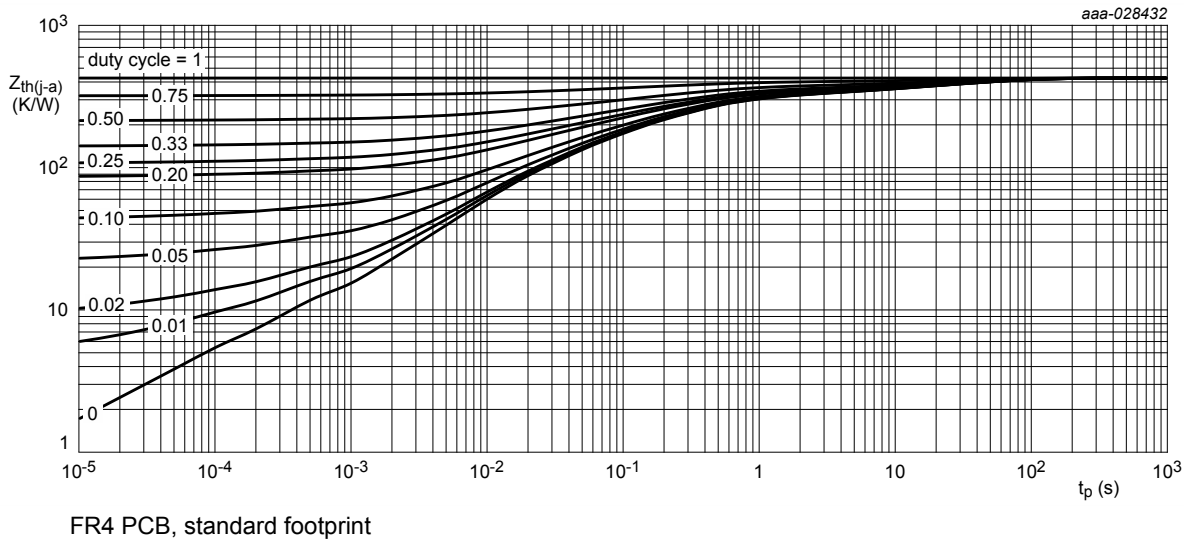


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

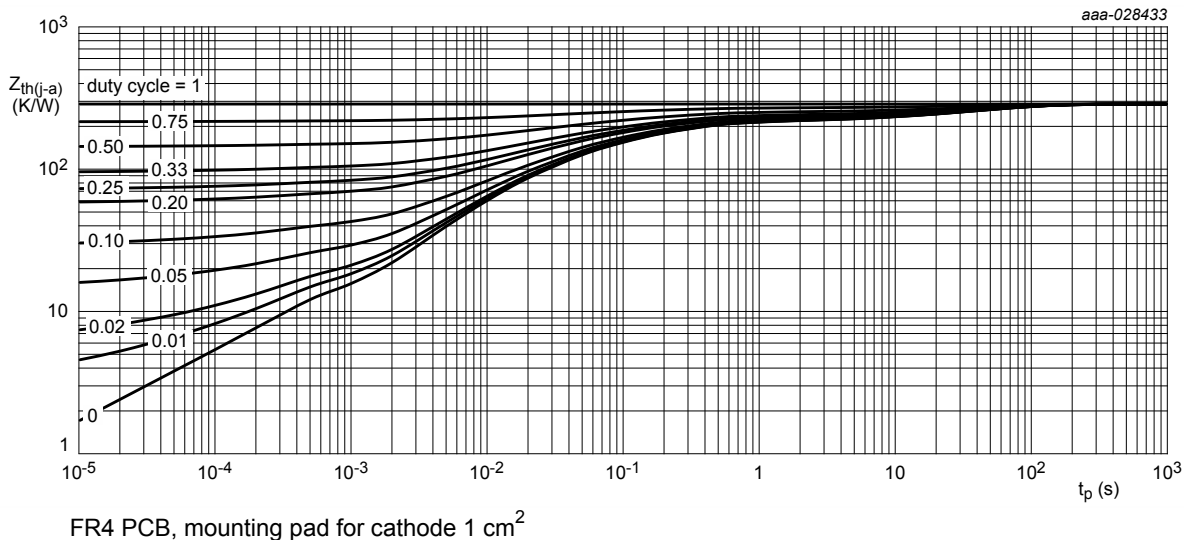


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_F	forward voltage	$I_F = 100\text{ mA}$; $t_p \leq 300\text{ }\mu\text{s}$; $\delta \leq 0.02$; $T_j = 25\text{ }^\circ\text{C}$	-	-	1	V
		$I_F = 200\text{ mA}$; $t_p \leq 300\text{ }\mu\text{s}$; $\delta \leq 0.02$; $T_j = 25\text{ }^\circ\text{C}$	-	-	1.25	V
I_R	reverse current	$V_R = 200\text{ V}$; pulsed; $T_j = 25\text{ }^\circ\text{C}$	-	-	100	nA
		$V_R = 200\text{ V}$; pulsed; $T_j = 150\text{ }^\circ\text{C}$	-	-	100	μA
C_d	diode capacitance	$V_R = 0\text{ V}$; $f = 1\text{ MHz}$; $T_j = 25\text{ }^\circ\text{C}$	-	-	2	pF
t_{rr}	reverse recovery time	$I_F = 30\text{ mA}$; $I_R = 30\text{ mA}$; $R_L = 100\text{ }\Omega$; $I_{R(\text{meas})} = 3\text{ mA}$; $T_j = 25\text{ }^\circ\text{C}$	-	-	50	ns

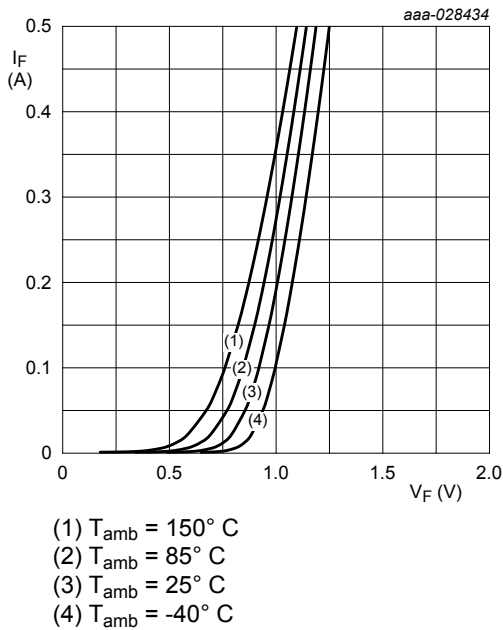


Fig. 3. Forward current as a function of forward voltage; typical values

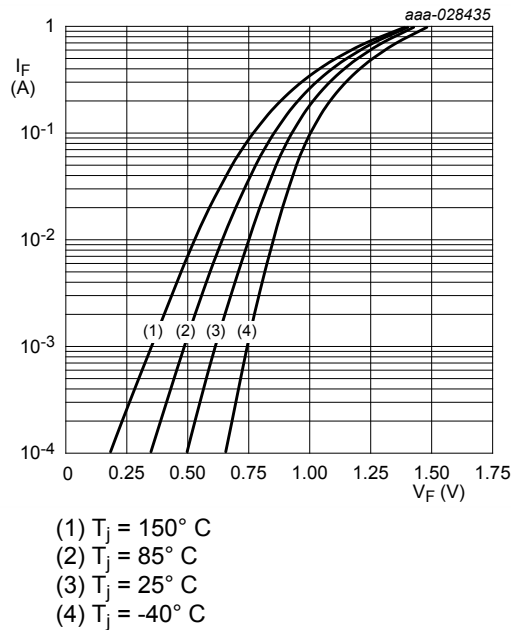


Fig. 4. Forward current as a function of forward voltage; typical values; (logarithmic scale)

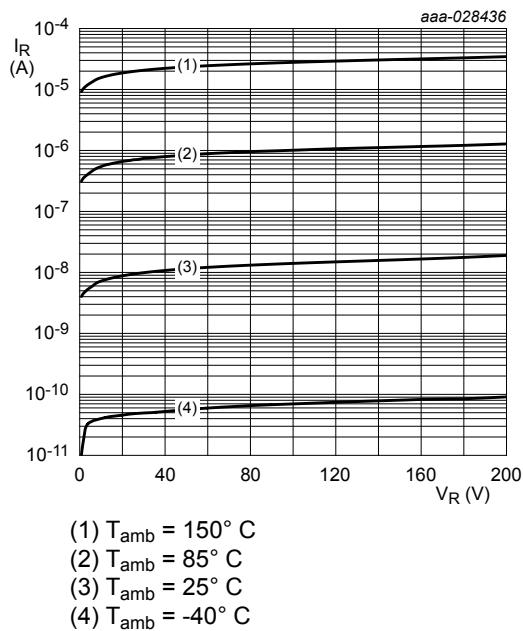


Fig. 5. Reverse current as a function of reverse voltage; typical values

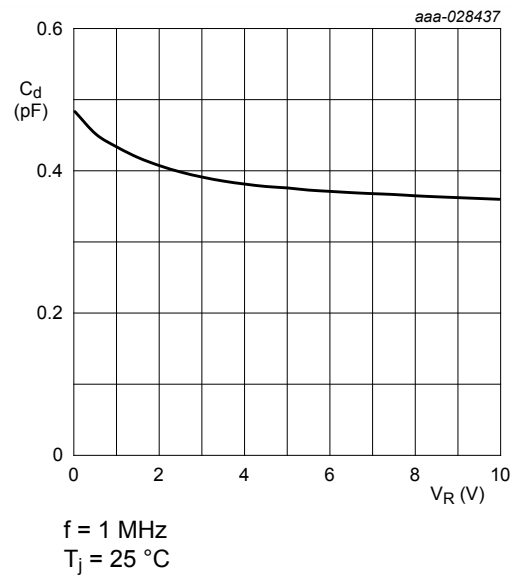
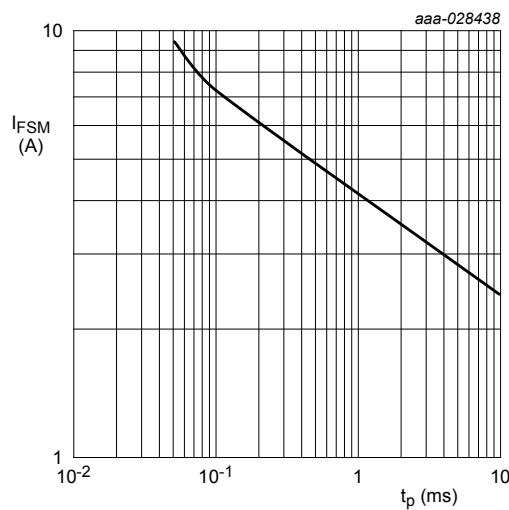


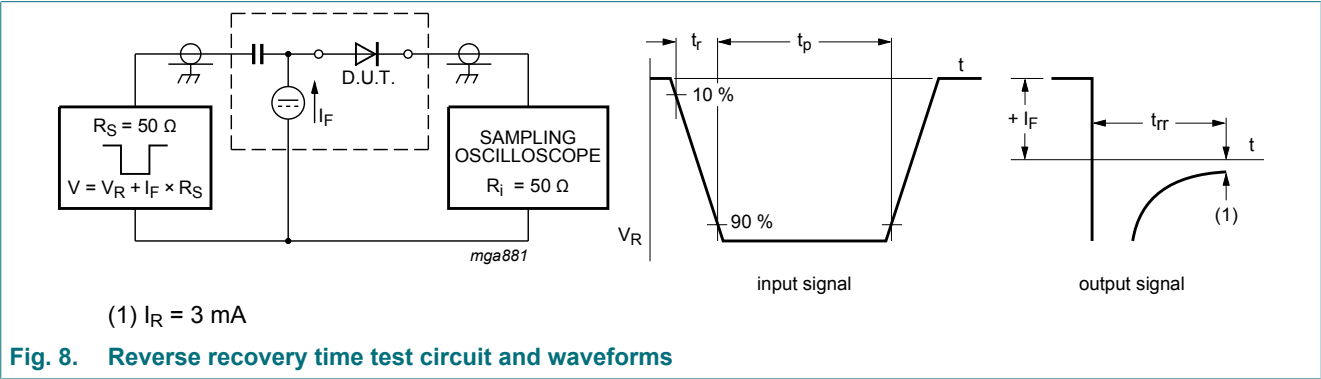
Fig. 6. Diode capacitance as a function of reverse voltage; typical values



Based on square wave currents.
 $T_{j(init)} = 25^\circ\text{C}$

Fig. 7. Non-repetitive peak forward current as a function of pulse Duration; Maximum values

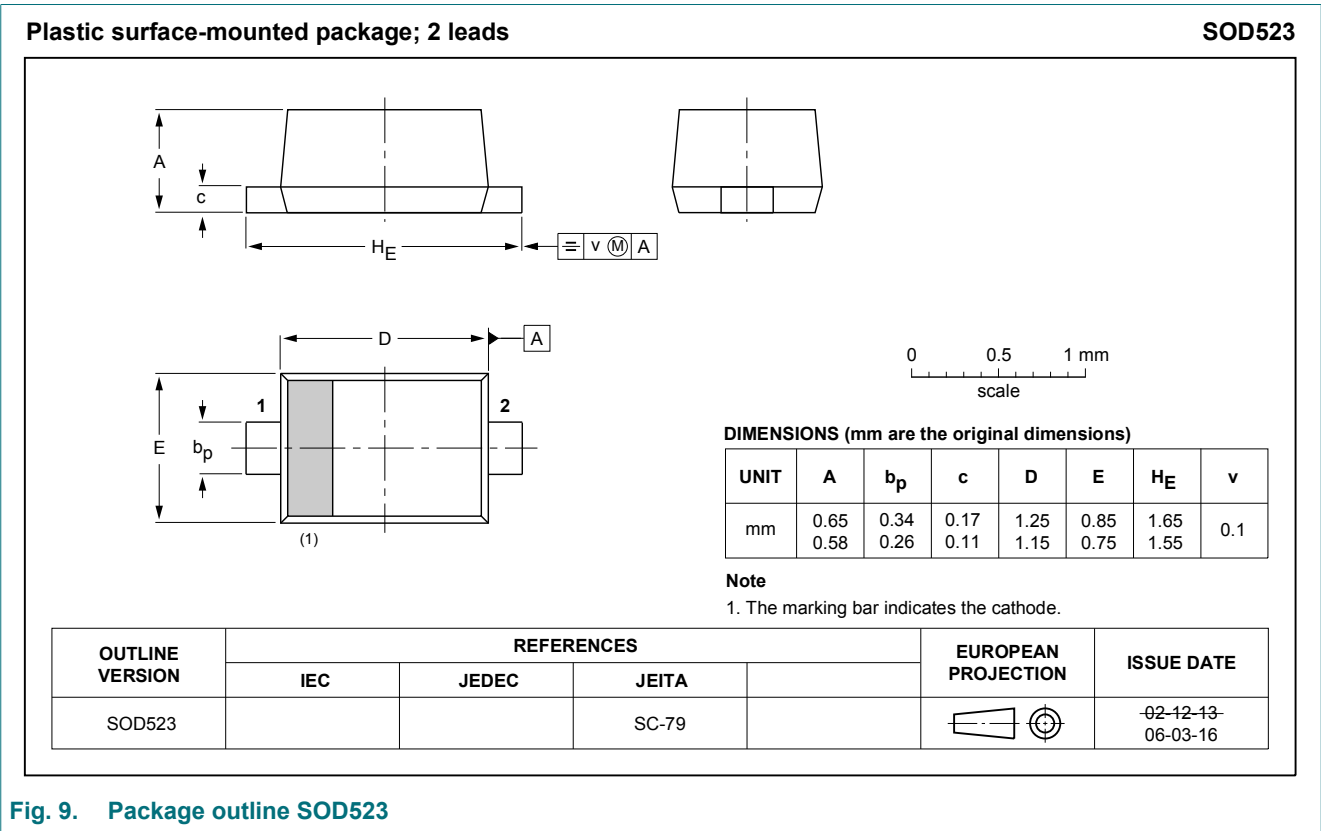
11. Test information



Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline



13. Soldering

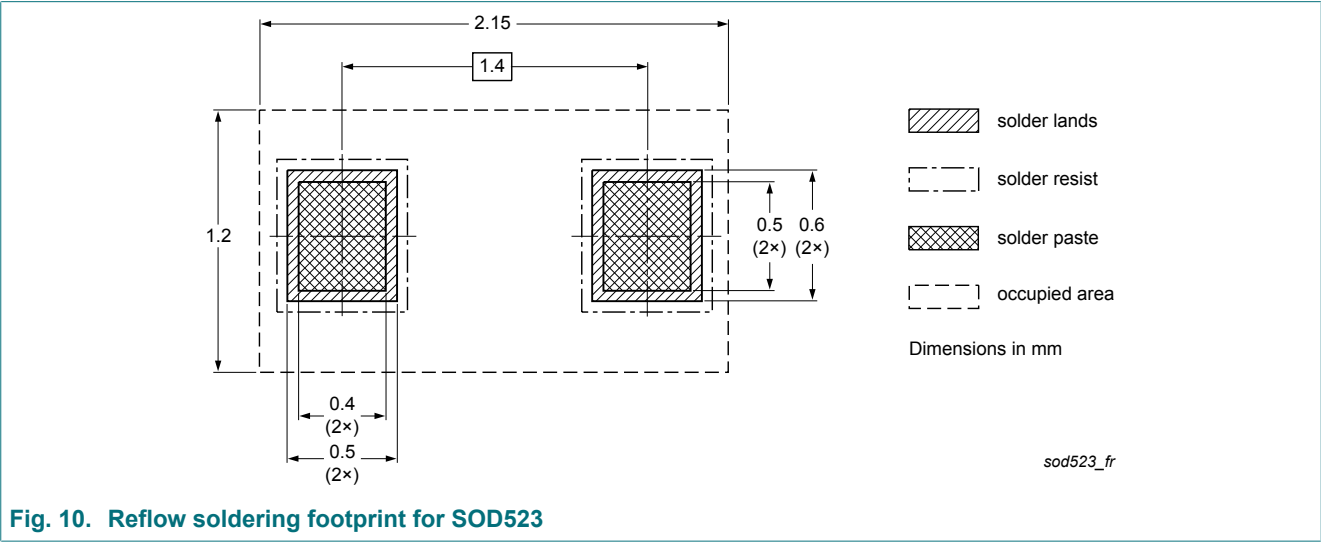


Fig. 10. Reflow soldering footprint for SOD523

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAS521B v.2	20180629	Product data sheet	-	BAS521B v.1
Modification:	<ul style="list-style-type: none">Figure 5: Unit for I_R corrected to A			
BAS521B v.1	20180502	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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